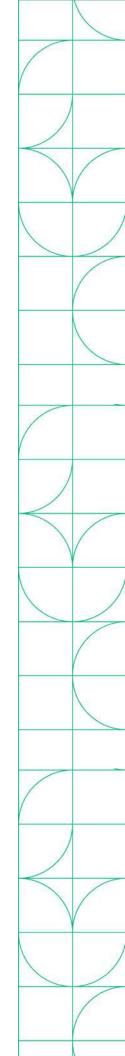


# PXIe-SCP5101 Bundle

Expandable PXI bundle based on PXIe-5110 Oscilloscope, 100 MHz, 8 bits, 2 Channels, 512 MB

**Specifications** 

PXIe-1083 and PXIe-5110

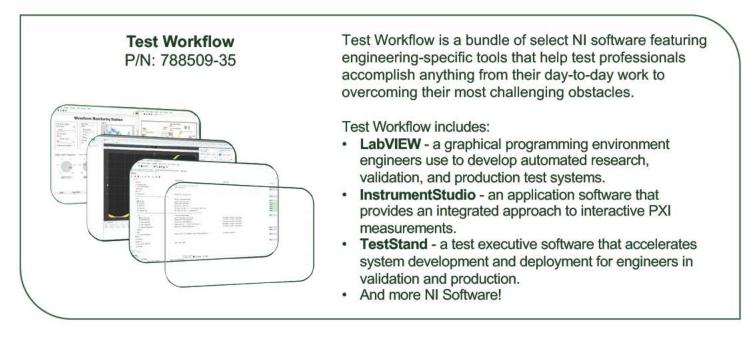


# PXI Oscilloscope Bundle

#### In the Box



#### **Recommended Software**



#### Table of Contents

This document combines the PDFs of this bundle together. The page numbers in the table of contents correspond to the page number of PDF the component's documentation begins.

PXIe-1083 Specifications	3
PXIe-5110 Specifications	16

# PXIe-1083 Specifications



# PXIe-1083 Specifications

This document contains specifications for the PXIe-1083 chassis.

## Electrical

The following section provides information about the PXIe-1083 AC input and DC output.

### **AC** Input

Input rating	100 VAC to 240 VAC, 50 Hz/60 Hz, 6 A to 3 A
Operating voltage range <sup>1</sup>	90 VAC to 264 VAC
Nominal input frequency	50 Hz/60 Hz
Operating frequency range <sup>1</sup>	47 Hz to 63 Hz
Efficiency	78% typical
Over-current protection	Internal fuse in line
Main power disconnect	The AC power cable provides main power disconnect. Do not position the equipment so that it is difficult to disconnect the power cord. The front-panel power switch causes the internal chassis power supply to provide DC power to the PXI Express backplane.



Caution Disconnect power cord to completely remove power.

#### **DC Output**

#### DC output characteristics of the PXIe-1083.

Voltage Rail	Maximum Current	Load Regulation	Maximum Ripple and Noise (20 MHz BW)
+5V_AUX	1.0 A	±5%	50 mVpp
+12 V	30.1 A	±5%	120 mVpp
+5 V	25.1 A	±5%	50 mVpp
+3.3 V	30.7 A	±5%	50 mVpp
-12 V	0.75 A	±5%	120 mVpp

Maximum total available power for the PXIe-1083 is 293 W.

The maximum combined power available on +3.3 V and +5 V is 180 W.

The maximum power available for each Thunderbolt port is 15 W (5 V/3 A).

#### Table 1. Backplane Slot Current Capacity

Slot	+5 V	V (I/O)	+3.3 V	+12 V	-12 V	5 V <sub>AUX</sub>
Hybrid Peripheral Slot with PXI-5 Peripheral	-	-	3 A	6 A	-	1 A
Hybrid Peripheral Slot with PXI-1 Peripheral	6 A	5 A	6 A	1 A	1 A	-

**Note** PCI V(I/O) pins in Hybrid Peripheral Slots are connected to +5 V.

Note The maximum power dissipated in a peripheral slot should not exceed 58 W. Refer to the **Operating Environment** section for ambient temperature considerations at 58 W.

Over-current protection	All outputs are protected from short circuit and overload, they recover and return to regulation when the overload is removed and the power is cycled.
Over-voltage	+3.3 V clamped at 3.7 V to 4.3 V, +5 V clamped at 5.7 V to 6.5 V,
protection	+12 V clamped at 13.4 V to 15.6 V

## Chassis Cooling

Module cooling	Forced air circulation (positive pressurization) through one 150 CFM fan
Module slot airflow direction	Bottom of module to top of module
Module intake	Bottom of chassis
Module exhaust	Top, right side of chassis
Slot cooling capacity	58 W; slot 6 supports 58 W cooling with high fan mode
Power supply cooling	Forced air circulation through integrated fans
Power supply intake	Front and left side chassis
Power supply exhaust	Rear of chassis
Minimum chassis cooling cl	earances
Above	44.45 mm (1.75 in.)
Rear	44.45 mm (1.75 in.)
Sides	44.45 mm (1.75 in.)
Below	
Rack	44.45 mm (1.75 in.)
Desktop	25.4 mm (1.00 in.)

## Environmental

Maximum altitude	2,000 m (6,560 ft.), 800 mbar (at 25 °C ambient, high fan mode)
Pollution Degree	2

Indoor use only.

## Operating Environment

Ambient temperature range	
When all peripheral modules	0 °C to 50 °C (IEC 60068-2-1 and IEC 60068-2-2.) <sup>2</sup> Meets
require ≤38 W cooling capacity	MIL-PRF-28800F Class 3 low temperature limit and high
per slot	temperature limit.
When any peripheral module	0 °C to 40 °C (IEC 60068-2-1 and IEC 60068-2-2.) <sup>2</sup> Meets
requires >38 W cooling capacity	MIL-PRF-28800F Class 3 low temperature limit and MIL-
per slot	PRF-28800F Class 4 high temperature limit.
Relative humidity range	20% to 80%, noncondensing

## Storage Environment

Ambient temperature range	–40 °C to 71 °C (IEC-60068-2-1 and IEC-60068-2-2.) <sup>[3]</sup> Meets MIL- PRF-28800F Class 3 limits.
Relative humidity range	10% to 95%, noncondensing

## Shock and Vibration

Operational shock	30 g peak, half-sine, 11 ms pulse (IEC-60068-2-27.) <sup>3</sup> Meets MIL- PRF-28800F Class 2 limits.
Operational random vibration	5 to 500 Hz, 0.3 g <sub>rms</sub>
Non-operating vibration	5 to 500 Hz, 2.4 g <sub>rms</sub> (IEC 60068-2-64.) <sup>3</sup> Non-operating test profile exceeds the requirements of MIL-PRF-28800F, Class 3.

## Acoustic Emissions

#### Sound Pressure Level (at Operator Position)

(Tested in accordance with ISO 7779. Meets MIL-PRF-28800F requirements.)

38 W Profile	
Auto fan (up to 30 °C ambient)	33.7 dBA
High fan	50.8 dBA
58 W Profile	
Auto fan (up to 30 °C ambient)	54.7 dBA
High fan	55.3 dBA

#### Sound Power Level

#### 38 W Profile

Auto fan (up to 30 °C ambient)	44.9 dBA
High fan	60.3 dBA
58 W Profile	
<b>58 W Profile</b> Auto fan (up to 30 °C ambient)	63.4 dBA

Note The protection provided by the PXIe-1083 can be impaired if it is used in a manner not described in this document.

## Safety Compliance Standards

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1

Note For safety certifications, refer to the product label or the <u>Product</u> <u>Certifications and Declarations</u> section.

## **EMC Guidelines**

This product was tested and complies with the regulatory requirements and limits for electromagnetic compatibility (EMC) stated in the product specifications. These requirements and limits provide reasonable protection against harmful interference when the product is operated in the intended operational electromagnetic environment. This product is intended for use in industrial locations. However, harmful interference may occur in some installations, when the product is connected to a peripheral device or test object, or if the product is used in residential areas. To minimize interference with radio and television reception and prevent unacceptable performance degradation, install and use this product in strict accordance with the instructions in the product documentation.

Furthermore, any changes or modifications to the product not expressly approved by NI could void your authority to operate it under your local regulatory rules.

#### **EMC** Notices

Refer to the following notices for cables, accessories, and prevention measures necessary to ensure the specified EMC performance.

## **N**otice

For EMC declarations and certifications, and additional information, refer to the <u>Product Certifications and Declarations</u> section.

**Notice** Changes or modifications to the product not expressly approved by NI could void your authority to operate the product under your local regulatory rules.

Notice Operate this product only with shielded cables and accessories.

#### **Electromagnetic Compatibility Standards**

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions

AS/NZS CISPR 11: Group 1, Class A emissions

**Note** Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



Note In Europe, Canada, Australia, and New Zealand (per CISPR 11) Class A equipment is intended for use in nonresidential locations.

# CE Compliance $C \in$

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)
- 2011/65/EU; Restriction of Hazardous Substances (RoHS)

## **Product Certifications and Declarations**

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

## **Environmental Management**

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Engineering a Healthy Planet** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

#### EU and UK Customers

• A Waste Electrical and Electronic Equipment (WEEE)—At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit <u>ni.com/environment/weee</u>.

#### 电子信息产品污染控制管理办法(中国 RoHS)

• ◎●● 中国 RoHS— NI 符合中国电子信息产品中限制使用某些有害物 质指令(RoHS)。关于 NI 中国 RoHS 合规性信息,请登录 ni.com/environment/ rohs\_china。(For information about China RoHS compliance, go to ni.com/ environment/rohs\_china.)

## Backplane

Size	3U-sized; 5 peripheral slots. Compliant with IEEE 1101.10 mechanical packaging. PXI Express Specification compliant. Accepts both PXI Express and CompactPCI (PICMG 2.0 R 3.0) 3U modules.
Backplane bare-board material	UL 94 V-0 Recognized
Backplane connectors	Conforms to IEC 917 and IEC 1076-4-101, UL 94 V-0 rated

#### System Synchronization Clocks

10 MHz System Reference Clock: PXI\_CLK10

Maximum slot-to-slot skew	250 ps
Accuracy	±25 ppm max (guaranteed over the operating temperature range)
Maximum jitter	5 ps RMS phase-jitter (10 Hz–1 MHz range)
Duty-factor	45% to 55%
Unloaded signal swing	3.3 V ±0.3 V



Note For other specifications, refer to the PXI-1 Hardware Specification.

#### 100 MHz System Reference Clock: PXIe\_CLK100 and PXIe\_SYNC100

Maximum slot-to-slot skew	100 ps
Accuracy	±25 ppm max (guaranteed over the operating temperature range)
Maximum jitter	3 ps RMS phase-jitter (10 Hz to 12 kHz range), 2 ps RMS phase-jitter (12 kHz to 20 MHz range)
Duty-factor for PXIe_CLK100	45% to 55%
Absolute differential voltage (When terminated with a 50 Ω load to 1.30 V or Thévenin equivalent)	400 mV to 1000 mV



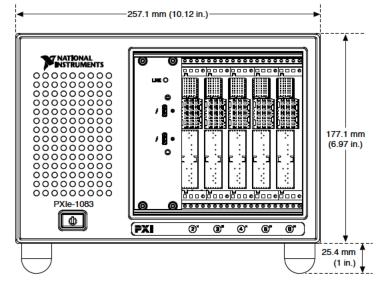
# Note For other specifications, refer to the PXI-5 PXI Express Hardware Specification.

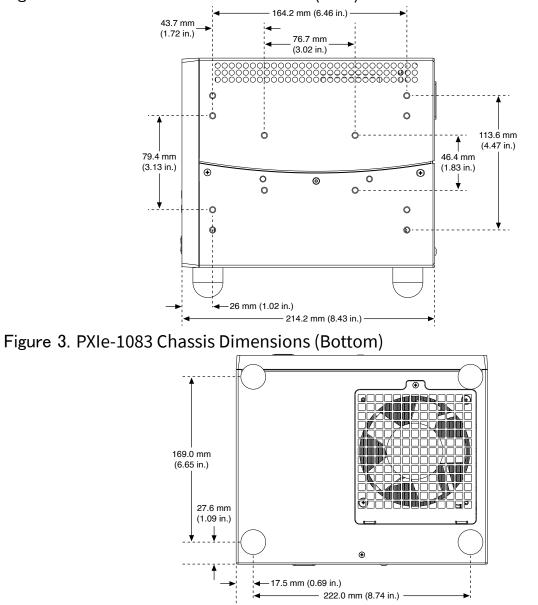
### Mechanical

Standard chassis	s dimensions
Height	177.1 mm (6.97 in.)
Width	257.1 mm (10.12 in.)
Depth	214.2 mm (8.43 in.)
Weight	6.7 kg (14.8 lb)
Chassis materials	Extruded Aluminum (6063-T5, 6060-T6), Cold Rolled Steel/Stainless Steel, Santoprene, Urethane Foam, PC-ABS, Nylon, Polyethylene
Finish	Conductive Clear Iridite on Aluminum, Electroplated Nickel on Cold Rolled Steel, Electroplated Zinc on Cold Rolled Steel

The following figures show the PXIe-1083 chassis dimensions. The holes shown are for installing the optional rack mount kits.

#### Figure 1. PXIe-1083 Chassis Dimensions (Front)





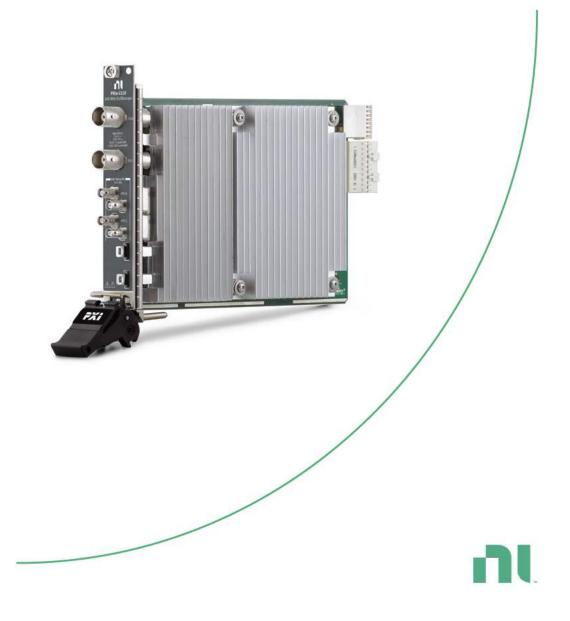
#### Figure 2. PXIe-1083 Chassis Dimensions (Side)

<sup>1</sup> The operating range is guaranteed by design.

<sup>2</sup> This product meets the requirements of the environmental standards for electrical equipment for measurement, control, and laboratory use.

<sup>3</sup> This product meets the requirements of the environmental standards for electrical equipment for measurement, control, and laboratory use.

# PXIe-5110 Specifications



# PXIe-5110 Specifications

These specifications apply to the PXIe-5110 with 64 MB and 512 MB of memory.

## Definitions

**Warranted** specifications describe the performance of a model under stated operating conditions and are covered by the model warranty. Warranted specifications account for measurement uncertainties, temperature drift, and aging. Warranted specifications are ensured by design or verified during production and calibration.

**Characteristics** describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- **Typical** specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.
- **Measured** specifications describe the measured performance of a representative model.

Specifications are **Nominal** unless otherwise noted.

## Conditions

Specifications are valid under the following conditions unless otherwise noted.

- All vertical ranges, bandwidths, and bandwidth limiting filters
- Sample rate set to 0.5 GS/s or 1 GS/s
- Onboard sample clock locked to PXI\_Clk100 reference clock
- 15-minute warm-up time at ambient temperature
- Chassis configured:<sup>[1]</sup>

- PXI Express chassis fan speed set to HIGH
- Foam fan filters removed if present
- Empty slots contain PXI chassis slot blockers and filler panels

**Warranted** specifications are valid under the following conditions unless otherwise noted.

- Ambient temperature range of 0 °C to 55 °C
- Altitude ≤2,000 m
- Calibration cycle maintained
- Self-calibration run after:
  - Warm-up time has elapsed
  - Module has been power cycled
  - PC or controller has been restarted or wakes from sleep or hibernation modes
- External calibration performed at 23 °C ±3 °C

**Typical** specifications are valid under the following conditions unless otherwise noted.

- Ambient temperature range of 0 °C to 55 °C
- Altitude ≤2,000 m

#### Vertical

#### Analog Input

Number of channels	Two (simultaneously sampled)
Input type	Referenced single-ended
Connectors	BNC, ground referenced

## Impedance and Coupling

Input impedance	50 Ω ±1.5%, typical
	1 M $\Omega$ ±1.0%, typical
Input capacitance (1 MΩ)	16 pF
Input coupling	AC
	DC

## Voltage Levels

#### Table 1. Full-Scale (FS) Input Range and Vertical Offset Range

Input Range (V <sub>pk-pk</sub> )		Vertical Offs	Vertical Offset Range	
_		50 Ω	1 MΩ	
0.04 V		±5 V		
0.1 V		±5 V		
0.2 V		±5 V		
0.4 V		±5 V		
1 V		±5 V	±20 V	
2 V		±5 V	±20 V	
4 V		±5 V	±20 V	
10 V		±2 V	±100 V	
20 V		_	±100 V	
40 V			±100 V	
Maximum input o	verload			
50 Ω	Peaks  ≤7 V	Peaks  ≤7 V		
1 MΩ <sup>[2]</sup>	Peaks  ≤250 V	DC		

Notice Signals exceeding the maximum input overload may cause damage to the device.

## Accuracy

Resolution	8 bits	
DC accuracy <sup>[3]</sup>		
50 Ω		
	±[(2% ×   <b>Reading</b> - <b>Vertical Offset</b>  ) + (0.4% ×   <b>Vertical Offset</b>  ) + (1% of FS)+ 0.2 mV], typical	
	±[(2% ×   <b>Reading</b> - <b>Vertical Offset</b>  ) + (0.4% ×   <b>Vertical Offset</b>  ) + (1% of FS)+ 0.2 mV], warranted	
	±[(2% ×   <b>Reading</b> - <b>Vertical Offset</b>  )+ (1.1% ×   <b>Vertical Offset</b>  ) + (1% of FS)+ 0.2 mV], warranted	
1 ΜΩ		
Input range: 0.04 V	±[(2% ×   <b>Reading</b> - <b>Vertical Offset</b>  ) + (0.4% ×   <b>Vertical Offset</b>  ) + (1% of FS)+ 0.2 mV], typical	
Input range: 0.1 V to 20 \	/ ±[(2% ×   <b>Reading</b> - <b>Vertical Offset</b>  ) + (0.4% ×   <b>Vertical Offset</b>  ) + (1% of FS)+ 0.2 mV], warranted	
Input range: 40 V	±[(2% ×   <b>Reading</b> - <b>Vertical Offset</b>  )+ (1.1% ×   <b>Vertical Offset</b>  ) + (1% of FS)+ 0.2 mV], warranted	
DC drift <sup>[4]</sup>	±[(0.036% ×   <b>Reading</b> - <b>Vertical Offset</b>  )+ (0.004% ×   <b>Vertical Offset</b>  ) + (0.012% of FS)] per °C	

AC amplitude accuracy <sup>[3]</sup>	±0.25 dB at 50 kHz
AC amplitude drift <sup>[4]</sup>	±0.0046 dB per °C at 50 kHz

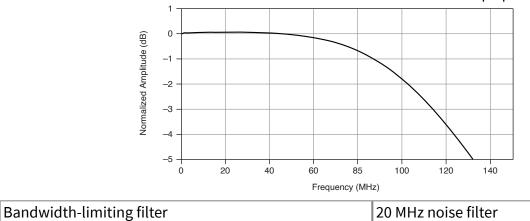
#### Crosstalk

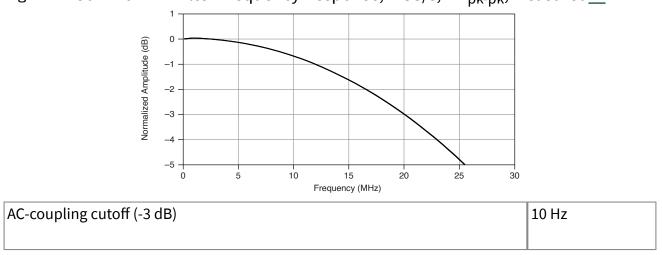
Crosstalk <sup>[5]</sup>	<-65 dB at input frequencies ≤100 MHz

#### Bandwidth and Transient Response



Figure 1. 50  $\Omega$  Full Bandwidth Frequency Response, 1 GS/s, 1 V<sub>pk-pk</sub>, Measured<sup>[6]</sup>





#### Figure 2. 50 $\Omega$ 20 MHz Filter Frequency Response, 1 GS/s, 1 V<sub>pk-pk</sub>, Measured<sup>[6]</sup>

Figure 3. Step Response, 50  $\Omega,$  1  $V_{pk\text{-}pk},$  500 ps Rising Edge, Measured

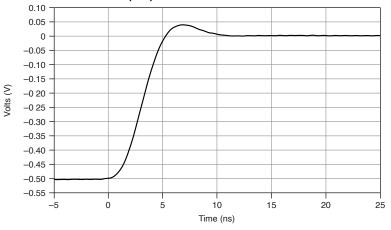
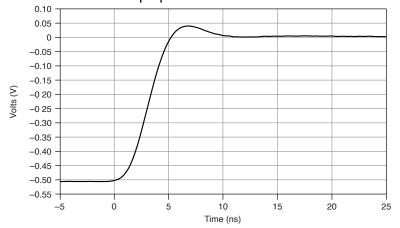


Figure 4. Step Response, 1 M\Omega, 1  $V_{pk\text{-}pk}$ , 500 ps Rising Edge, Measured



## Spectral Characteristics<sup>[7]</sup>

Spurious-free dynamic range (SFDR) <sup>[8]</sup>	-50 dBc

#### Table 2. Effective Number of Bits (ENOB)<sup>[9]</sup>

Input Range (V <sub>pk-pk</sub> )	Filters	
_	20 MHz filter enabled	Full bandwidth (Input Frequency <50 MHz)
0.1 V to 4 V	7.2	6.9
0.04 V	6.8 6.6	
Total harmonic distortion (THD) <sup>[8]</sup> -50 dBc		-50 dBc

#### Noise

RMS noise <sup>[10]</sup>	0.3% of FS	

## Horizontal

## Sample Clock

Source	Onboard clock (internal oscillator)
Sample rate range, real time <sup>[11]</sup>	7.63 kS/s to 500 MS/s
Sample rate, time-interleaved sampling (TIS) mode <sup>[12]</sup>	1 GS/s
Timebase frequency	500 MHz
Timebase accuracy <sup>[13]</sup>	±50 ppm

Sample clock jitter <sup>[14]</sup>	2 ps RMS

## Phase-Locked Loop (PLL) Reference Clock

Sources		
Internal	Onboard clock (internal oscillator)	
External	PXI_Clk100 (backplane connector)	
Duty cycle tolerand	ce	45% to 55%, typical

## Triggers

Supported triggers	Reference (Stop) Trigger Reference (Arm) Trigger Start Trigger (Acquisition Arm) Advance Trigger
Trigger types	Edge Glitch Hysteresis Runt Width Window

	Digital	
	Immediate	
	Software	
Trigger sources	СН 0	
	CH 1	
	PFI <03>	
	PXI_Trig <07>	
Minimum dead time	·	
Interpolator enabled	600 ns	
Interpolator disabled	400 ns	
Trigger delay	0 to $2.25 \times 10^{15}$ ns [(2 <sup>51</sup> - 1) * <b>Sample Clock Period</b> ]	
Holdoff	Dead time to 1.84 × 10 <sup>19</sup> ns [(2 <sup>64</sup> - 1) * <b>Sample Clock Period</b> ]	

## Analog Trigger

Sources	СН 0
	CH 1

#### Table 3. Analog Trigger Time Resolution

Interpolator Status	Time Resolution	
	TIS Enabled	TIS Disabled
Enabled	0.977 ps	1.95 ps

Interpolator Status	Time Resolution	
	TIS Enabled	TIS Disabled
Disabled	1 ns	2 ns
Trigger filters		
Low frequency (LF) reject	ct 100 kHz	
High frequency (HF) reject		100 kHz
Minimum threshold duration <sup>[15]</sup>	Sa	mple clock period

## **Digital Trigger**

Sources	ces PFI <03> (front panel HD-BNC connectors) PXI_Trig <07> (backplane connector)	
Time resolutio	<b>n</b> 2 ns	
PXI_Trig	8 ns	

# Programmable Function Interface (PFI)

Connectors	PFI <03> (front panel HD-BNC connectors)	
Direction	Bidirectional per channel	
<b>As an input (trigger)</b> Destinations	Start Trigger (Acquisition Arm)	

	Reference (Stop) Trigger
	Reference (Arm) Trigger
	Advance Trigger
Input impedance	49.9 kΩ
V <sub>IH</sub>	2 V, typical
V <sub>IL</sub>	0.8 V, typical
Recommended input range	0 V to 3.3 V
Maximum input overload	+5 V tolerant
Minimum pulse width	10 ns
As an output (event)	
Sources	Ready for Start
	Start Trigger (Acquisiton Arm)
	Ready for Reference
	Reference (Stop) Trigger
	End of Record
	Ready for Advance
	Advance Trigger
	Done (End of Acquisition)

Output impedance	50 Ω	
Logic type	3.3 V CMOS	
Maximum current drive	12 mA	
Maximum frequency	50 MHz	
Minimum pulse width	10 ns	

## Probe Compensation

Connectors	Probe compensation terminal
	Ground terminal
Output voltage <sup>[16]</sup>	0 V to 5 V
Maximum overload voltage	25 V DC

## CableSense

CableSense pulse voltage[17]	0.4 V
CableSense pulse rise time <sup>[18]</sup>	4 ns

Driver support for CableSense on the PXIe-5110 was first available in NI-SCOPE18.7.

#### Related information

• For more information about CableSense technology, refer to ni.com/ cablesense.

## Waveform Memory

Available onboard memory sizes <sup>[19]</sup>			
		512 MB	
Minimum record length	1 sample		
Number of samples			
Pretrigger 0 up to ( <b>Record Length</b> - 1)			
Posttrigger 0 up to <b>Record Length</b>			
Maximum number of records in onboard memory <sup>[20]</sup>		100,000	

#### Table 4. Examples of Allocated Onboard Memory per Record, 512 MB Option

Channels	Bytes per Sample	Maximum Records per Channel	Record Length	Allocated Onboard Memory per Record
1	1	100,000	1	192
1	1	100,000	1,000	1,200
1	1	52,924	10,000	10,176
1	1	1	536,870,785	536,870,976
2	1	100,000	1	192
2	1	100,000	1,000	2,208
2	1	26,672	10,000	20,160
2	1	1	268,435,393	536,870,976

## Calibration

### **External Calibration**

External calibration corrects the onboard references for gain and offset errors used in self-calibration and adjusts the compensation attenuator. All calibration constants are stored in nonvolatile memory.

## Self-Calibration

Self-calibration is done on software command. The calibration corrects for gain, offset, interleaving spurs, and intermodule synchronization errors. Run self-calibration after the specified warm-up time has elapsed and any time the module is power cycled or the PC or controller is restarted or wakes from sleep or hibernation modes. Refer to the **NI High-Speed Digitizers Help** at <u>ni.com/manuals</u> for more information on when to self-calibrate the device.

## **Calibration Specifications**

Interval for external calibration	2 years
Warm-up time <sup>[21]</sup>	15 minutes

## Software

#### **Driver Software**

Driver support for this device was first available in NI-SCOPE18.6.

NI-SCOPE is an IVI-compliant driver that allows you to configure, control, and calibrate the PXIe-5110. NI-SCOPE provides application programming interfaces for many development environments.

#### Application Software

NI-SCOPE provides programming interfaces, documentation, and examples for the following application development environments:

- LabVIEW
- LabWindows<sup>™</sup>/CVI<sup>™</sup>
- Measurement Studio
- Microsoft Visual C/C++
- .NET (C# and VB.NET)

#### Interactive Soft Front Panel and Configuration

When you install NI-SCOPE on a 64-bit system, you can use InstrumentStudio to monitor, control, and record measurements from the PXIe-5110.

InstrumentStudio is an application that allows you to perform interactive measurements on several different NI device types in a single application.

Interactive control of the PXIe-5110 was first available via InstrumentStudio in NI-SCOPE18.6. InstrumentStudio is included on the NI-SCOPE media.

NI Measurement & Automation Explorer (MAX) also provides interactive configuration and test tools for the PXIe-5110. MAX is included on the driver media.

## Synchronization

Channel-to-channel skew, between the channels of a PXIe-5110		
50 Ω	<100 ps	
1 ΜΩ	<100 ps	

## Synchronization with the NI-TClk API [22]

NI-TClk is an API that enables system synchronization of supported PXI modules in one or more PXI chassis, which you can use with the PXIe-5110 and NI-SCOPE.

NI-TClk uses a shared Reference Clock and triggers to align the Sample Clocks of PXI modules and synchronize the distribution and reception of triggers. These signals are routed through the PXI chassis backplane without external cable connections between PXI modules in the same chassis.

Module-to-module skew, between PXIe-5110 modules using NI-TClk [23]		
NI-TClk synchronization without manual adjustment [24]		
Skew, peak-to-peak [25]	200 ps	
Jitter, peak-to-peak <sup>[26]</sup>	120 ps	
NI-TClk synchronization with manual adjustment <sup>[24]</sup>		
Skew, average [25]	10 ps	
Jitter, peak-to-peak [26]	8 ps	
Sample Clock delay/adjustment resolution		<1 ps

#### Power

Current draw		
+3.3 V DC	1.82 A	
+12 V DC	0.83 A	

Power draw		
+3.3 V DC	6 W	
+12 V DC	10 W	
Total	16 W	
Total maximum power allowed		30 W

## Physical

Dimensions	3U, one-slot, PXI Express/CompactPCI Express module
	2.0 cm × 13.0 cm × 21.6 cm
	(0.8 in × 5.1 in × 8.5 in)
Weight	380 g (13.4 oz)

### **Bus Interface**

Form factor	Gen 1 x4 module
Slot compatibility	PXI Express or hybrid

## **Environmental Characteristics**

Temperature		
Operating	0 °C to 55 °C	

Storage	-40 °C to 71 °C		
Humidity			
Operating	10% to 90%, noncondensing		
Storage	5% to 95%, noncondensing		
Pollution Degree	:	2	
Maximum altitude	·	4,600 m (at 25 °C ambient temperature)	
Shock and Vibration			
Operating vibration		5 Hz to 500 Hz, 0.3 g RMS	
Non-operating vibration		5 Hz to 500 Hz, 2.4 g RMS	
Operating shock		30 g, half-sine, 11 ms pulse	

## **Product Certifications and Declarations**

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

<sup>1</sup> For more information about cooling, refer to the **Maintain Forced-Air Cooling Note to Users** available at <u>ni.com/manuals</u>.

<sup>2</sup> Derate above 250 kHz at 20 dB/dec until 2.5 MHz, then derate at 5 dB/dec.

 $\frac{3}{2}$  Within ±5 °C of self-calibration temperature.

 $\frac{4}{2}$  Used to calculate errors when the onboard temperature changes more than ±5 °C from the self-calibration temperature.

<sup>5</sup> Measured on one channel with test signal applied to another channel and the same range setting on both channels.

<sup>6</sup> Normalized to 50 kHz.

<sup>7</sup> Excludes ADC interleaving spurs.

<sup>8</sup> Input frequencies <50 MHz, input range ≤4 V<sub>pk-pk</sub>. -1 dBFS input signal. Includes second through fifth harmonics.

<sup>9</sup> Input frequencies <50 MHz. -1 dBFS input signal corrected to FS. 1 kHz resolution bandwidth.

 $\frac{10}{2}$  Applies to all filter settings and input modes. Verified using a 50  $\Omega$  terminator connected to input.

<sup>11</sup> Divide by **n** decimation from 500 MS/s. For more information on the sample clock and decimation, refer to the **NI High-Speed Digitizers Help**.

 $\frac{12}{2}$  Single channel only.

<sup>13</sup> Phase-locked to onboard clock. The default clock is PXI\_Clk100. Refer to your chassis specifications for the timebase accuracy of PXI\_Clk100.

 $\frac{14}{2}$  Integrated from 100 Hz to 10 MHz. Includes the effects of converter aperture uncertainty and the clock circuitry jitter. Excludes trigger jitter.

 $\frac{15}{15}$  Data must exceed each corresponding trigger threshold for at least this minimum duration to ensure analog triggering.

 $\frac{16}{1}$  1 kHz, 50% duty cycle square wave.

 $\frac{17}{2}$  When measured with a high-impedance device.

 $\frac{18}{2}$  When sourcing into a 50  $\Omega$  cable or load.

 $\frac{19}{19}$  Onboard memory is shared among all enabled channels.

<sup>20</sup> For 512 MB option. You can exceed this value if you fetch records while acquiring data. For more information, refer to the Enable Records > Memory property in the **NI High-Speed Digitizers Help** at <u>ni.com/manuals</u>.

 $\frac{21}{21}$  Warm-up time begins after the chassis and either the controller or PC is powered and NI-SCOPE is loaded.

 $\frac{22}{2}$  NI-TClk installs with NI-SCOPE.

<sup>23</sup> Although you can use NI-TClk to synchronize non-identical modules, these specifications apply only to synchronizing identical modules. Specifications are valid under the following conditions:

- All modules installed in the same PXI Express chassis
- NI-TClk used to align the sample clocks of each module
- All parameters set to identical values for each module
- Self-calibration completed
- Ambient temperature within ±1 °C of self-calibration

For other configurations, including multi-chassis systems, contact NI Technical Support at <u>ni.com/support</u>.

<sup>24</sup> Manual adjustment is the process of minimizing synchronization jitter and skew by adjusting Trigger Clock (TClk) signals using the instrument driver.

 $\frac{25}{25}$  **Skew** is the misalignment between module timing across slots of a chassis and is caused by clock and analog path delay differences.

 $\frac{26}{\text{NI-TClkSynchronize}}$ .